# S1AFG, S1AFJ, S1AFK, S1AFM

Vishay General Semiconductor

RoHS COMPLIANT

HALOGEN

**FREE** 

### **Surface-Mount Glass Passivated Rectifier**

# eSMP<sup>®</sup> Series

**Bottom View** 



SlimSMA (DO-221AC)

Cathode O Anode

#### **DESIGN SUPPORT TOOLS**

**Top View** 

click logo to get started



PRIMARY CHARACTERISTICS					
I <sub>F(AV)</sub>	1.0 A				
V <sub>RRM</sub>	400 V, 600 V, 800 V, 1000 V				
I <sub>FSM</sub>	35 A				
I <sub>R</sub>	5 μΑ				
V <sub>F</sub> at I <sub>F</sub> = 1.0 A (125 °C)	0.85 V				
T <sub>J</sub> max.	150 °C				
Package	SlimSMA (DO-221AC)				
Circuit configuration	Single				

#### **FEATURES**

- Very low profile typical height of 0.95 mm
- Ideal for automated placement
- · Glass passivated pellet chip junction
- Low forward voltage drop
- · Low leakage current
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

#### TYPICAL APPLICATIONS

For use in general purpose rectification of power supplies, inverters, converters and freewheeling diodes for consumer, and industrial applications

#### **MECHANICAL DATA**

Case: SlimSMA (DO-221AC)

Molding compound meets UL 94 V-0 flammability rating

Base P/N-M3 - halogen-free, RoHS-compliant

Terminals: matte tin plated leads, solderable per

J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 2 whisker test **Polarity:** color band denotes cathode end

MAXIMUM RATINGS (T <sub>A</sub> = 25 °C unless otherwise noted)						
PARAMETER	SYMBOL	S1AFG	S1AFJ	S1AFK	S1AFM	UNIT
Device marking code		SG	SJ	SK	SM	
Maximum repetitive peak reverse voltage	$V_{RRM}$	400	600	800	1000	V
Maximum average forward rectified current	I <sub>F(AV)</sub> (1)	1.0				А
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I <sub>FSM</sub>	35				А
Operating junction and storage temperature range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150				°C

#### Notes

(1) Free air, mounted on recommended copper pad area

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<b>ELECTRICAL CHARACTERISTICS</b> (T <sub>A</sub> = 25 °C unless otherwise noted)							
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT	
Instantaneous forward voltage	I <sub>F</sub> = 0.5 A	———— T₁ = 25 °C	V <sub>F</sub> (1)	0.90	-	V	
	I <sub>F</sub> = 1.0 A			0.95	1.1		
	I <sub>F</sub> = 0.5 A	- T <sub>A</sub> = 125 °C		0.78	-		
	I <sub>F</sub> = 1.0 A			0.85	0.98		
Max. reverse current	Rated V <sub>R</sub>	T <sub>A</sub> = 25 °C	I <sub>R</sub> <sup>(2)</sup>	1 (2)	-	5.0	
	nated v <sub>R</sub>	T <sub>A</sub> = 125 °C		-	100	μΑ	
Typical reverse recovery time	I <sub>F</sub> = 0.5 A, I <sub>R</sub> = 1.0 A, I <sub>rr</sub> = 0.25 A		t <sub>rr</sub>	1.47	-	μs	
Typical junction capacitance	4.0 V, 1 MHz		CJ	7.9	-	pF	

#### **Notes**

 $^{(1)}\,$  Pulse test: 300  $\mu s$  pulse width, 1 % duty cycle

(2) Pulse test: Pulse width ≤ 40 ms

THERMAL CHARACTERISTICS (T <sub>A</sub> = 25 °C unless otherwise specified)						
PARAMETER	SYMBOL	S1AFG	S1AFJ	S1AFK	S1AFM	UNIT
Typical thermal resistance	R <sub>0</sub> JA (1)	125				°C/W
	R <sub>0JM</sub> (2)	23				C/VV

#### Notes

<sup>(1)</sup> Free air, mounted on recommended PCB, 2 oz. pad area; thermal resistance  $R_{\theta JA}$  - junction to ambient,  $R_{\theta JM}$  - junction to mount

 $^{(2)}$  Mounted on 5.0 mm x 5.0 mm pad areas, 2 oz. FR4 PCB;  $R_{\theta JM}$  - junction to mount

ORDERING INFORMATION (Example)						
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE		
S1AFJ-M3/6A	0.032	6A	3500	7" diameter plastic tape and reel		
S1AFJ-M3/6B	0.032	6B	14 000	13" diameter plastic tape and reel		

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### RATINGS AND CHARACTERISTICS CURVES (T<sub>A</sub> = 25 °C unless otherwise specified)

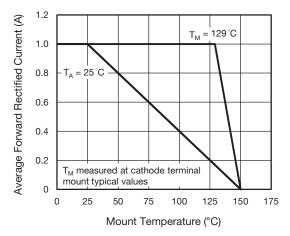


Fig. 1 - Maximum Forward Current Derating Curve

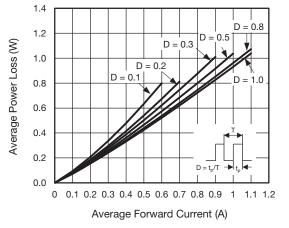


Fig. 2 - Average Power Loss Characteristics

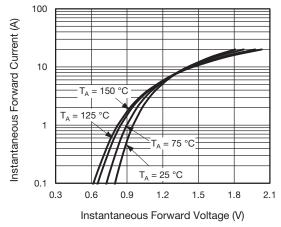


Fig. 3 - Typical Instantaneous Forward Characteristics

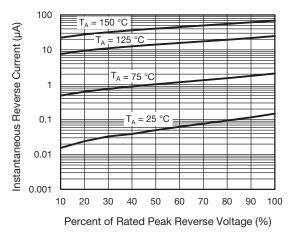


Fig. 4 - Typical Reverse Leakage Characteristics

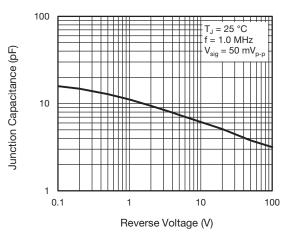


Fig. 5 - Typical Junction Capacitance

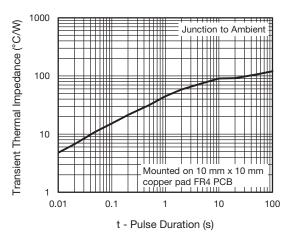


Fig. 6 - Typical Transient Thermal Impedance

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#### **PACKAGE OUTLINE DIMENSIONS** in inches (millimeters)

#### SlimSMA (DO-221AC) Cathode Band 0.057 (1.45) 0.106 (2.70) 0.049 (1.25) 0.098 (2.50) 0.171 (4.35) Typ.: 0.019 (0.48) 0.047 (1.20) 0.163 (4.15) 0.030 (0.75) 0.211 (5.35) 0.199 (5.05) **Mounting Pad Layout** 0.039 (1.00) 0.035 (0.90) 0.060 (1.52) 0.012 (0.30) MIN. 0.006 (0.15) 0.123 (3.12) MAX. 0.047 (1.20) MIN. 0.047 (1.20) 0.217 (5.52) REF.



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